

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY UARIANT: TIDA-00177_production

| PCB UIEWED FROM TOP SIDE | BOARD \#: TIDA-00177 | REU: Rev E1 | SUN REU: Not In Uer sionControl |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  |  |  |  |
| PLOT NAME $=$ Top Assembly Drawing | GENERATED | $: 6 / 25 / 2015$ | $12: 33: 19$ | PM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY UARIANT: TIDA-00177_production

| PCB UIEWED FROM BOTTOM SIDE | BOARD \#: TIDA-00177 | REU: Rev E1 | SUN REU: Not In Uer sionControl |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  |  |  |  |
| PLOT NAME $=$ Bottom Assembly Drawing | GENERATED | : 6/25/2015 | $12: 33: 21$ | PM | TEXAS INSTRUMENTS |

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